

## 1. General description

Ultrafast power diode in a SOD142 (2-lead TO247) plastic package.

## 2. Features and benefits

- Fast switching and soft reverse recovery characteristics
- Low forward voltage drop
- Low leakage current
- Low reverse recovery current
- Reduces switching losses in associated MOSFET or IGBT

## 3. Applications

- UPS
- EV Charger
- Welding Machine
- Air Conditioner

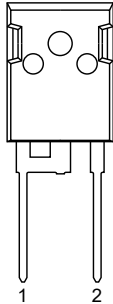

## 4. Quick reference data

Table 1. Quick reference data

| Symbol                         | Parameter                           | Conditions                                                                                                                         | Min | Typ  | Max | Unit |
|--------------------------------|-------------------------------------|------------------------------------------------------------------------------------------------------------------------------------|-----|------|-----|------|
| $V_R$                          | reverse voltage                     | DC                                                                                                                                 | -   | -    | 600 | V    |
| $I_{F(AV)}$                    | average forward current             | $\delta = 0.5$ ; $T_{mb} \leq 129$ °C; square-wave pulse; <a href="#">Fig. 1</a> ; <a href="#">Fig. 2</a> ; <a href="#">Fig. 3</a> | -   | -    | 60  | A    |
| $I_{FSM}$                      | non-repetitive peak forward current | $t_p = 10$ ms; $T_{j(init)} = 25$ °C; sine-wave pulse; <a href="#">Fig. 4</a>                                                      | -   | -    | 600 | A    |
|                                |                                     | $t_p = 8.3$ ms; $T_{j(init)} = 25$ °C; sine-wave pulse; <a href="#">Fig. 4</a>                                                     | -   | -    | 660 | A    |
| <b>Static characteristics</b>  |                                     |                                                                                                                                    |     |      |     |      |
| $V_F$                          | forward voltage                     | $I_F = 60$ A; $T_j = 25$ °C; <a href="#">Fig. 6</a>                                                                                | -   | 1.55 | 2   | V    |
|                                |                                     | $I_F = 60$ A; $T_j = 150$ °C; <a href="#">Fig. 6</a>                                                                               | -   | 1.2  | 1.6 | V    |
| <b>Dynamic characteristics</b> |                                     |                                                                                                                                    |     |      |     |      |
| $t_{rr}$                       | reverse recovery time               | $I_F = 1$ A; $V_R = 30$ V; $dI_F/dt = 50$ A/ $\mu$ s; $T_j = 25$ °C; <a href="#">Fig. 7</a>                                        | -   | -    | 55  | ns   |

## 5. Pinning information

Table 2. Pinning information

| Pin | Symbol | Description                         | Simplified outline                                                                                                                   | Graphic symbol                                                                      |
|-----|--------|-------------------------------------|--------------------------------------------------------------------------------------------------------------------------------------|-------------------------------------------------------------------------------------|
| 1   | K      | cathode                             |  <p style="text-align: center;">TO-247 (SOD142)</p> |  |
| 2   | A      | anode                               |                                                                                                                                      |                                                                                     |
| mb  | mb     | mounting base; connected to cathode |                                                                                                                                      |                                                                                     |

## 6. Ordering information

Table 3. Ordering information

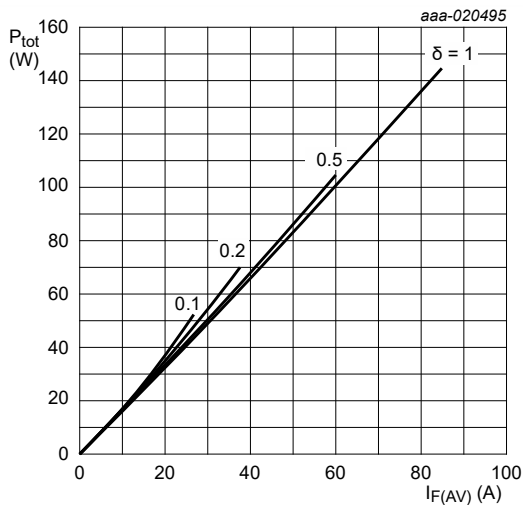
| Type number | Package |                                                                                             |         |
|-------------|---------|---------------------------------------------------------------------------------------------|---------|
|             | Name    | Description                                                                                 | Version |
| BYV60W-600P | TO-247  | Plastic Single-ended through-hole package; Heatsink mounted; 1 mounting hole; 2-lead TO-247 | SOD142  |

## 7. Limiting values

**Table 4. Limiting values**

In accordance with the Absolute Maximum Rating System (IEC 60134).

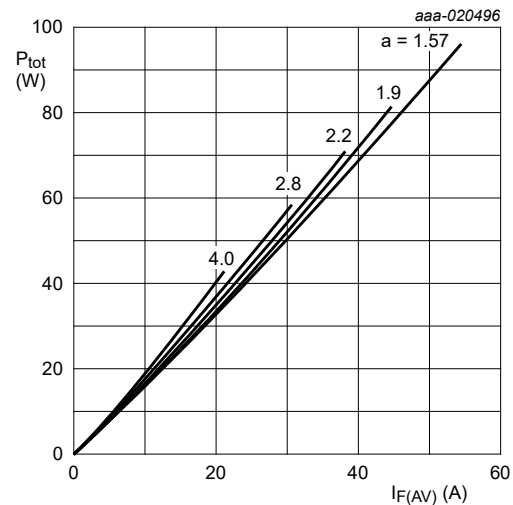
| Symbol      | Parameter                           | Conditions                                                                                                                                             | Min | Max | Unit             |
|-------------|-------------------------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------|-----|-----|------------------|
| $V_{RRM}$   | repetitive peak reverse voltage     |                                                                                                                                                        | -   | 600 | V                |
| $V_{RWM}$   | crest working reverse voltage       |                                                                                                                                                        | -   | 600 | V                |
| $V_R$       | reverse voltage                     | DC                                                                                                                                                     | -   | 600 | V                |
| $I_{F(AV)}$ | average forward current             | $\delta = 0.5$ ; $T_{mb} \leq 129\text{ }^\circ\text{C}$ ; square-wave pulse; <a href="#">Fig. 1</a> ; <a href="#">Fig. 2</a> ; <a href="#">Fig. 3</a> | -   | 60  | A                |
| $I_{FRM}$   | repetitive peak forward current     | $\delta = 0.5$ ; $t_p = 25\text{ }\mu\text{s}$ ; $T_{mb} \leq 129\text{ }^\circ\text{C}$ ; square-wave pulse                                           | -   | 120 | A                |
| $I_{FSM}$   | non-repetitive peak forward current | $t_p = 10\text{ ms}$ ; $T_{j(\text{init})} = 25\text{ }^\circ\text{C}$ ; sine-wave pulse; <a href="#">Fig. 4</a>                                       | -   | 600 | A                |
|             |                                     | $t_p = 8.3\text{ ms}$ ; $T_{j(\text{init})} = 25\text{ }^\circ\text{C}$ ; sine-wave pulse; <a href="#">Fig. 4</a>                                      | -   | 660 | A                |
| $T_{stg}$   | storage temperature                 |                                                                                                                                                        | -55 | 175 | $^\circ\text{C}$ |
| $T_j$       | junction temperature                |                                                                                                                                                        | -   | 175 | $^\circ\text{C}$ |



$$I_{F(AV)} = I_{F(RMS)} \times \sqrt{\delta}$$

$$V_o = 1.600\text{ V}; R_s = 0.001\text{ }\Omega$$

**Fig. 1. Forward power dissipation as a function of average forward current; square waveform; maximum values**



$$a = \text{form factor} = I_{F(RMS)} / I_{F(AV)}$$

$$V_o = 1.600\text{ V}; R_s = 0.001\text{ }\Omega$$

**Fig. 2. Forward power dissipation as a function of average forward current; sinusoidal waveform; maximum values**

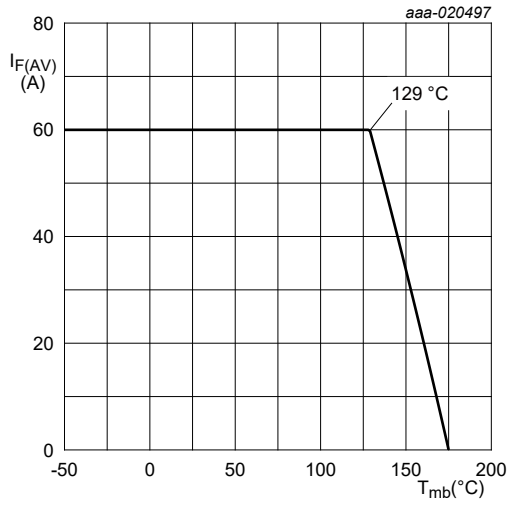


Fig. 3. Forward current as a function of mounting base temperature; maximum values

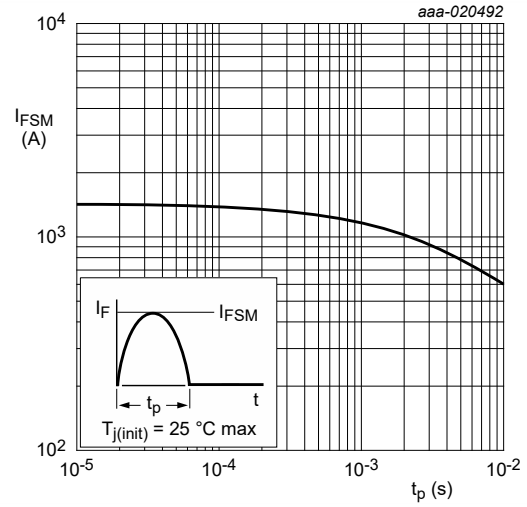


Fig. 4. Non-repetitive peak forward current as a function of pulse width; sinusoidal waveform; maximum values

### 8. Thermal characteristics

Table 5. Thermal characteristics

| Symbol         | Parameter                                            | Conditions                                     | Min | Typ | Max  | Unit |
|----------------|------------------------------------------------------|------------------------------------------------|-----|-----|------|------|
| $R_{th(j-mb)}$ | thermal resistance from junction to mounting base    | with heatsink compound; <a href="#">Fig. 5</a> | -   | -   | 0.44 | K/W  |
| $R_{th(j-a)}$  | thermal resistance from junction to ambient free air | in free air                                    | -   | 45  | -    | K/W  |

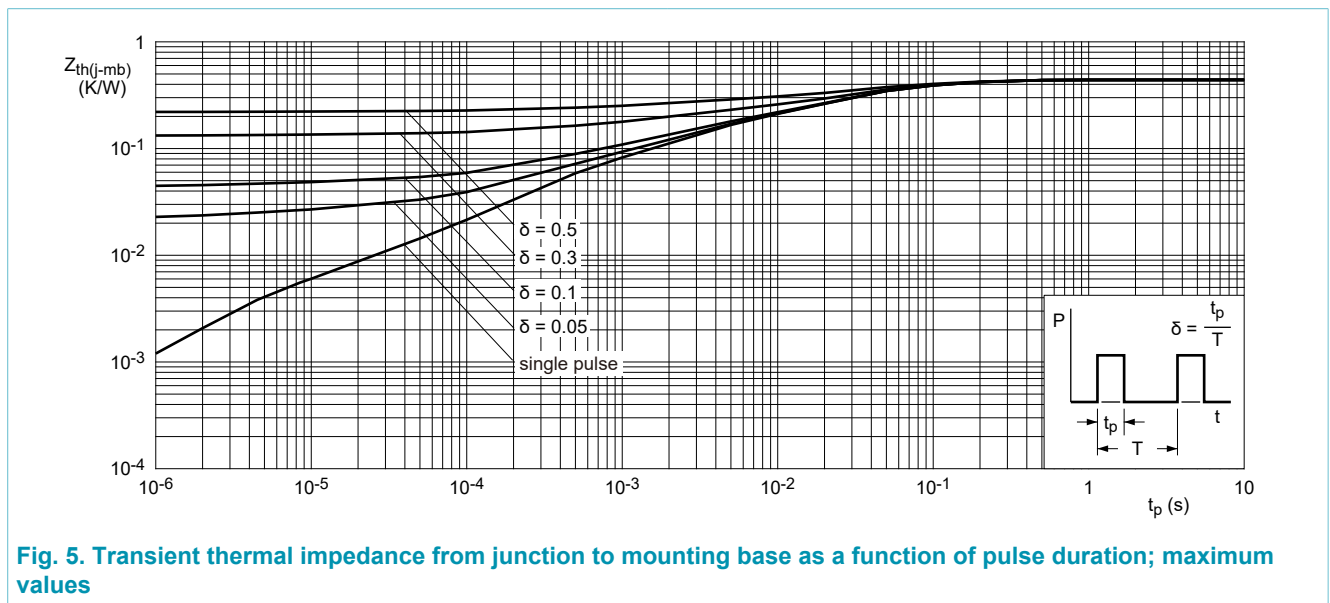


Fig. 5. Transient thermal impedance from junction to mounting base as a function of pulse duration; maximum values

### 9. Characteristics

Table 6. Characteristics

| Symbol                         | Parameter                       | Conditions                                                                                                                       | Min | Typ  | Max | Unit          |
|--------------------------------|---------------------------------|----------------------------------------------------------------------------------------------------------------------------------|-----|------|-----|---------------|
| <b>Static characteristics</b>  |                                 |                                                                                                                                  |     |      |     |               |
| $V_F$                          | forward voltage                 | $I_F = 60 \text{ A}; T_j = 25 \text{ }^\circ\text{C}; \text{ Fig. 6}$                                                            | -   | 1.55 | 2   | V             |
|                                |                                 | $I_F = 60 \text{ A}; T_j = 150 \text{ }^\circ\text{C}; \text{ Fig. 6}$                                                           | -   | 1.2  | 1.6 | V             |
| $I_R$                          | reverse current                 | $V_R = 600 \text{ V}; T_j = 25 \text{ }^\circ\text{C}$                                                                           | -   | -    | 10  | $\mu\text{A}$ |
|                                |                                 | $V_R = 600 \text{ V}; T_j = 125 \text{ }^\circ\text{C}$                                                                          | -   | -    | 500 | $\mu\text{A}$ |
| <b>Dynamic characteristics</b> |                                 |                                                                                                                                  |     |      |     |               |
| $t_{rr}$                       | reverse recovery time           | $I_F = 1 \text{ A}; V_R = 30 \text{ V}; dI_F/dt = 50 \text{ A}/\mu\text{s}; T_j = 25 \text{ }^\circ\text{C}; \text{ Fig. 7}$     | -   | -    | 55  | ns            |
|                                |                                 | $I_F = 60 \text{ A}; V_R = 400 \text{ V}; dI_F/dt = 200 \text{ A}/\mu\text{s}; T_j = 25 \text{ }^\circ\text{C}; \text{ Fig. 7}$  | -   | 53   | -   | ns            |
|                                |                                 | $I_F = 60 \text{ A}; V_R = 400 \text{ V}; dI_F/dt = 200 \text{ A}/\mu\text{s}; T_j = 125 \text{ }^\circ\text{C}; \text{ Fig. 7}$ | -   | 120  | -   | ns            |
| $I_{RM}$                       | peak reverse recovery current   | $I_F = 60 \text{ A}; V_R = 400 \text{ V}; dI_F/dt = 200 \text{ A}/\mu\text{s}; T_j = 25 \text{ }^\circ\text{C}; \text{ Fig. 7}$  | -   | 5.4  | -   | A             |
|                                |                                 | $I_F = 60 \text{ A}; V_R = 200 \text{ V}; dI_F/dt = 200 \text{ A}/\mu\text{s}; T_j = 125 \text{ }^\circ\text{C}; \text{ Fig. 7}$ | -   | 14.5 | -   | A             |
| $Q_r$                          | recovered charge                | $I_F = 60 \text{ A}; V_R = 400 \text{ V}; dI_F/dt = 200 \text{ A}/\mu\text{s}; T_j = 25 \text{ }^\circ\text{C}; \text{ Fig. 7}$  | -   | 143  | -   | nC            |
|                                |                                 | $I_F = 60 \text{ A}; V_R = 400 \text{ V}; dI_F/dt = 200 \text{ A}/\mu\text{s}; T_j = 125 \text{ }^\circ\text{C}; \text{ Fig. 7}$ | -   | 876  | -   | nC            |
| $E_{AS}$                       | non-repetitive avalanche energy | $I_R = 2.2 \text{ A}; T_{j(\text{init})} = 25 \text{ }^\circ\text{C}; L = 40 \text{ mH}$                                         | -   | 97   | -   | mJ            |

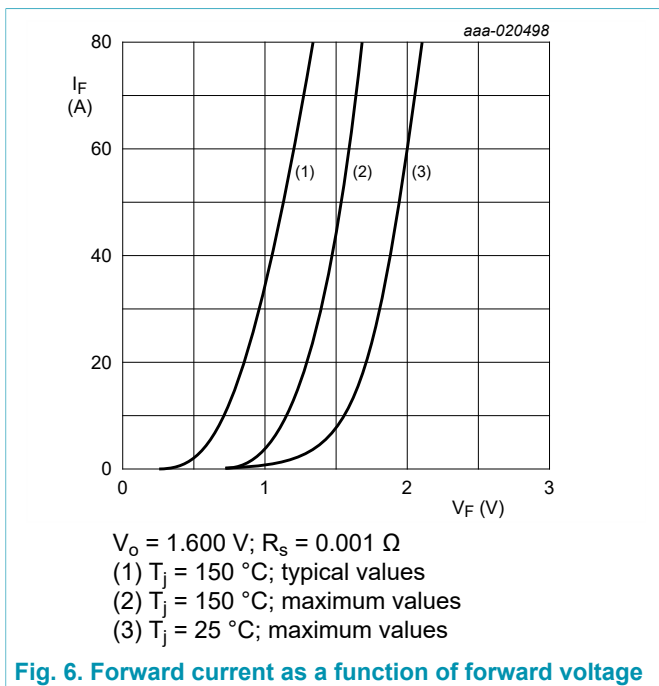


Fig. 6. Forward current as a function of forward voltage

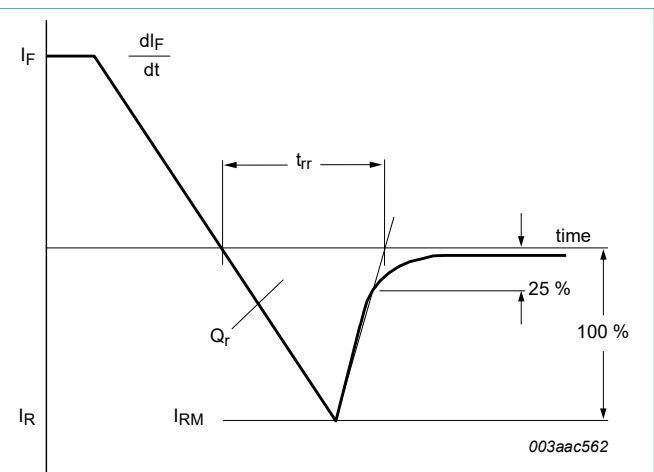
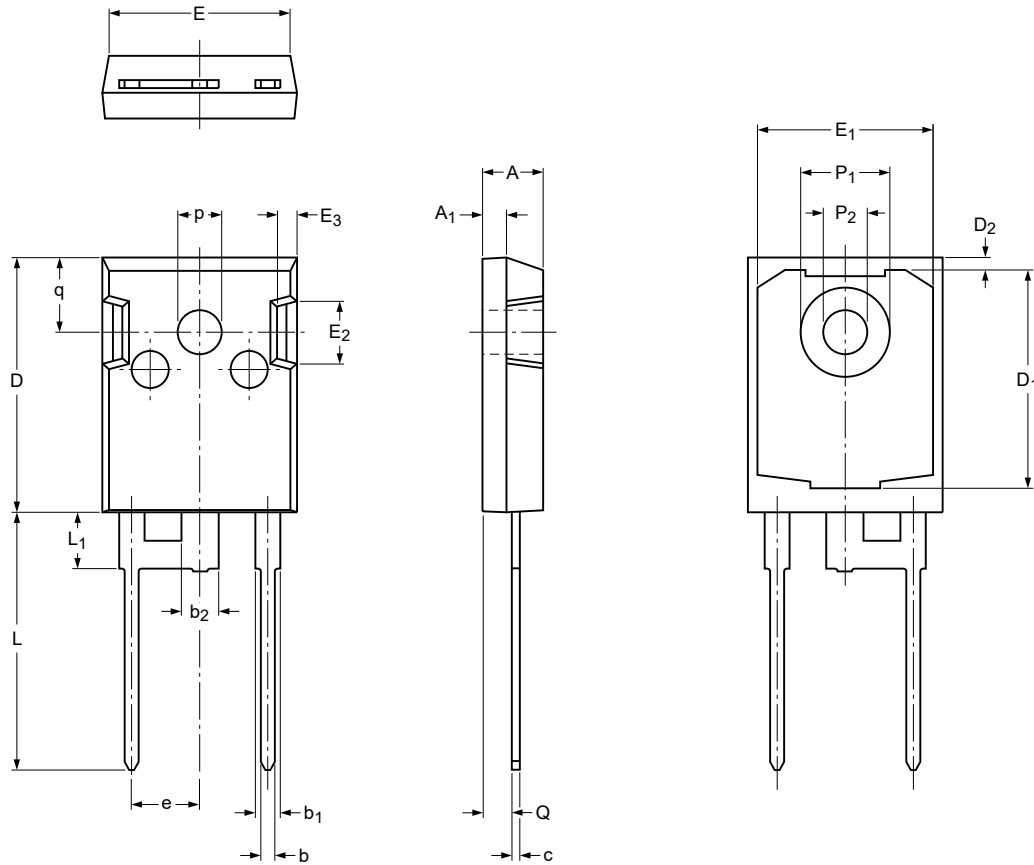


Fig. 7. Reverse recovery definitions; ramp recovery

### 10. Package outline

Plastic Single-ended through-hole package; Heatsink mounted; 1 mounting hole; 2-lead TO-247 SOD142



Dimensions (mm are the original dimensions)

| Unit | A   | A <sub>1</sub> | b   | b <sub>1</sub> | b <sub>2</sub> | c   | D    | D <sub>1</sub> | D <sub>2</sub> | e     | E     | E <sub>1</sub> | E <sub>2</sub> | E <sub>3</sub> | L    | L <sub>1</sub> | p   | p <sub>1</sub> | p <sub>2</sub> | q   | Q |
|------|-----|----------------|-----|----------------|----------------|-----|------|----------------|----------------|-------|-------|----------------|----------------|----------------|------|----------------|-----|----------------|----------------|-----|---|
| max  | 5.2 | 2.1            | 1.4 | 2.2            | 3.2            | 0.7 | 20.6 | 17.68          | 1.2            | 15.75 | 14.22 | 5.2            | 1.8            | 20.9           | 4.75 | 3.7            | 7.3 | 3.6            | 6.18           | 2.6 |   |
| nom  |     |                |     |                |                |     |      |                |                | 5.45  |       |                |                |                |      |                |     |                |                |     |   |
| min  | 4.7 | 1.9            | 1.0 | 1.8            | 2.8            | 0.5 | 20.3 | 17.28          | 0.8            | 15.45 | 13.82 | 4.8            | 1.4            | 20.4           | 4.25 | 3.5            | 7.1 | 3.4            | 5.78           | 2.2 |   |

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| Outline version | References |       |       | European projection | Issue date             |
|-----------------|------------|-------|-------|---------------------|------------------------|
|                 | IEC        | JEDEC | JEITA |                     |                        |
| SOD142          |            | TO247 |       |                     | -12-11-13-<br>12-11-27 |

Fig. 8. Package outline TO-247 (SOD142)

## 11. Legal information

### Data sheet status

| Document status [1][2]         | Product status [3] | Definition                                                                            |
|--------------------------------|--------------------|---------------------------------------------------------------------------------------|
| Objective [short] data sheet   | Development        | This document contains data from the objective specification for product development. |
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- [1] Please consult the most recently issued document before initiating or completing a design.
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